

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Morio GAKU et al. :
Serial No. NEW : **Attn: APPLICATION BRANCH**
Filed March 31, 2004 : Attorney Docket No. 2004_0517

METHOD OF MAKING THROUGH HOLE
WITH LASER, COPPER-CLAD LAMINATE
SUITABLE FOR MAKING HOLE, AND
AUXILIARY MATERIAL FOR MAKING
HOLE

(Rule 1.53(b) Divisional
of Serial No. 10/028,734,
Filed December 28, 2001)

CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

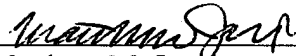
Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application Nos. 10-068357, filed March 18, 1998; 10-140472, filed May 7, 1998; 10-145206, filed May 12, 1998; 10-145205, filed May 12, 1998; 10-250447, filed August 20, 1998; 10-216411, filed July 15, 1998; 10-166324, filed May 29, 1998; 10-167759, filed June 1, 1998; and 10-167760, filed June 1, 1998, as acknowledged in the Declaration of this application.

Certified copies of said Japanese Patent Applications are of record in parent application Serial No. 09/271,897, filed March 18, 1999.

Respectfully submitted,

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